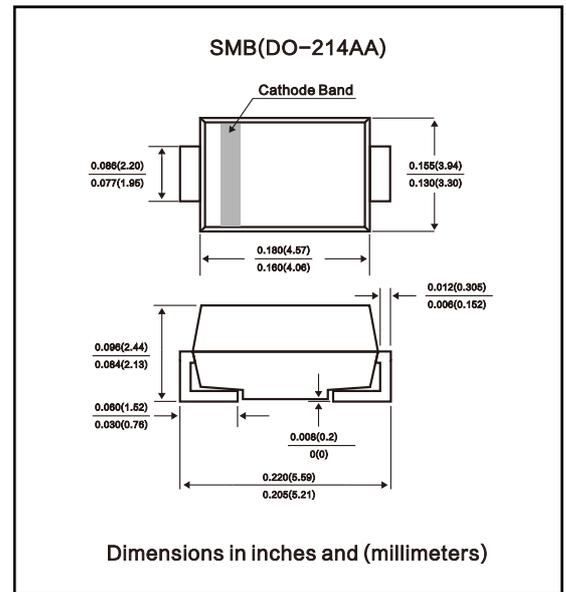


FEATURES

The plastic package carries Underwriters Laboratory
 Flammability Classification 94V-0
 For surface mounted applications
 Low reverse leakage
 Built-in strain relief, ideal for automated placement
 High forward surge current capability
 High temperature soldering guaranteed:
 250°C/10 seconds at terminals
 Glass passivated chip junction

MECHANICAL DATA

Case: JEDEC DO-214AA molded plastic body over passivated chip
Terminals: Solder plated, solderable per MIL-STD-750,
 Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.007 ounce, 0.25grams


MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated,
 for capacitive load, derate current by 20%)

	SYMBOL	GS 3A	GS 3B	GS 3D	GS 3G	GS 3J	GS 3K	GS 3M	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{rms}	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	V _{dc}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current 3/8"lead length at T _L =75°C	I _{f(av)}	3.0							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{fsm}	100.0							A
Maximum Forward Voltage at rated Forward current	V _f	1.1							V
Maximum DC Reverse Current at rated DC blocking voltage	I _r	5.0 250							μA
Typical Reverse Recovery Time (Note 1)	T _{rr}	2.3							us
Typical Junction Capacitance (Note 2)	C _j	60.0							pF
Typical Thermal Resistance (Note 3)	R _{th(ja)}	47.0							°C/W
	R _{th(jl)}	13.0							
	R _{th(jc)}	28.0							
Storage and Operating Temperature Range	T _{stg}	-50 to +150							°C

Note:

- Reverse Recovery Condition I_f =0.5A, I_r =1.0A, I_{rr} =0.25A
- Measured at 1.0 MHz and applied voltage of 4.0Vdc
- Thermal Resistance from junction to ambient and from junction to lead mounted on 8×8mm copper pad area

AVERAGE FORWARD RECTIFIED CURRENT,
AMPERES

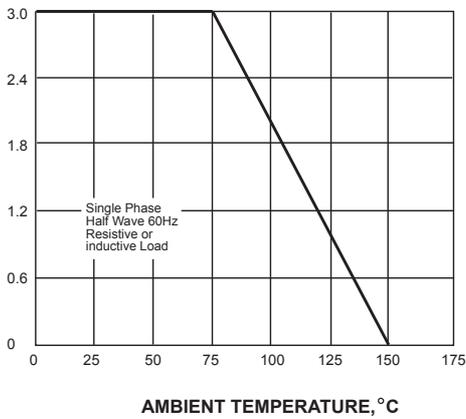
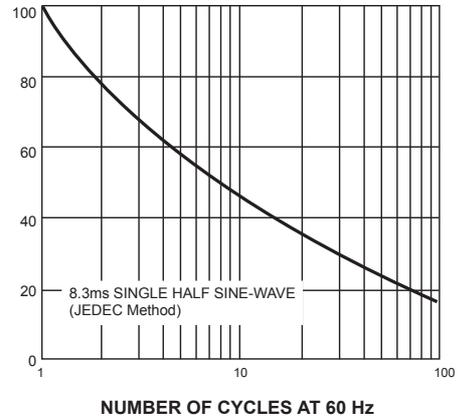
FIG. 1- FORWARD CURRENT DERATING CURVE

 PEAK FORWARD SURGE CURRENT,
AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT


INSTANTANEOUS FORWARD CURRENT,AMPERES

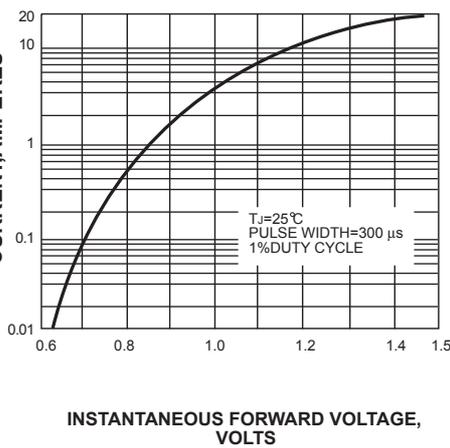
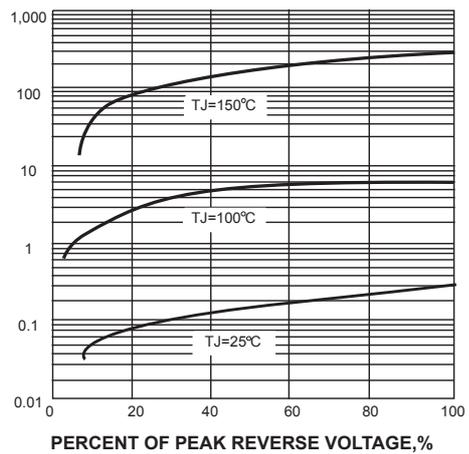
FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

 INSTANTANEOUS REVERSE CURRENT,
MICROAMPERES

FIG. 4-TYPICAL REVERSE CHARACTERISTICS


JUNCTION CAPACITANCE, pF

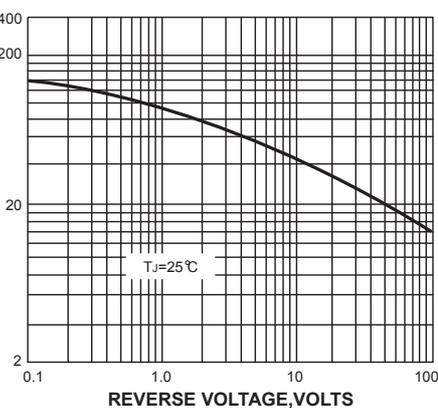
FIG. 5-TYPICAL JUNCTION CAPACITANCE

 TRANSIENT THERMAL IMPEDANCE,
°C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE
